

适用于 2 节、3 节和 4 节式锂离子电池且具有稳压输出电源的 bq296xxx 过压保护

1 特性

- 2 节、3 节和 4 节电池过压保护 (OVP)
- 固定延迟定时器，用于触发场效应晶体管 (FET) 驱动输出
(3s、4s、5.5s 或 6.5s 四种选项)
- 出厂设定的 OVP 阈值 (阈值电压范围为 3.85V 至 4.6V)
- 输出选项：高电平有效
- 高精度过压保护： $\pm 10\text{mV}$
- 具有自禁能和/或外部使能/禁能控制功能的稳压电源输出
 - 选项：3.3V、2.5V 和 1.8V (bq2960、bq2961)
 - 选项：3.3V、3.15V、3.0V (bq2962)
- 低功耗 $I_{CC} \approx 4\text{ }\mu\text{A}$
($V_{CELL(ALL)} < V_{PROTECT}$)
- 禁用 REG 输出时具有超低功耗， I_{CC} 约为 $1.2\text{ }\mu\text{A}$
- 每节电池输入的低泄漏电流 $< 100\text{nA}$
- 小型封装尺寸
 - 8 引脚 WSON (2 mm × 2 mm)

2 应用

- 笔记本电脑
- 超极本
- 医疗
- 不间断电源 (UPS) 备用电池

3 说明

bq296xxx 系列是一款高精度低功耗过压保护器，具有 1mA 稳压输出电源，适用于锂离子电池组应用。

该器件可为 2-4 节串联电池组中的每节电池单独监视过压情况。检测到任意一节电池上出现过压情况后，内部的固定延迟定时器便会启动；一旦延迟定时器到期，输出引脚便会被触发进入有效状态以指示出现过压情况。

稳压输出电源最高可提供 1mA (最大值) 输出电流，以驱动始终接通的电路，例如实时时钟 (RTC) 振荡器。bq296xxx 系列具有自禁能功能，能够在任意一节电池的电压低于特定阈值时关闭稳压输出，从而防止电池电量耗尽；该器件还可从外部控制稳压输出的使能或禁能。

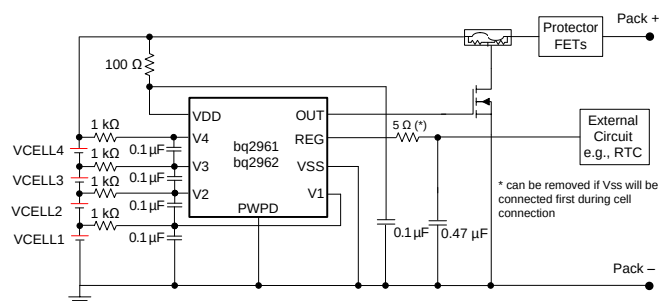
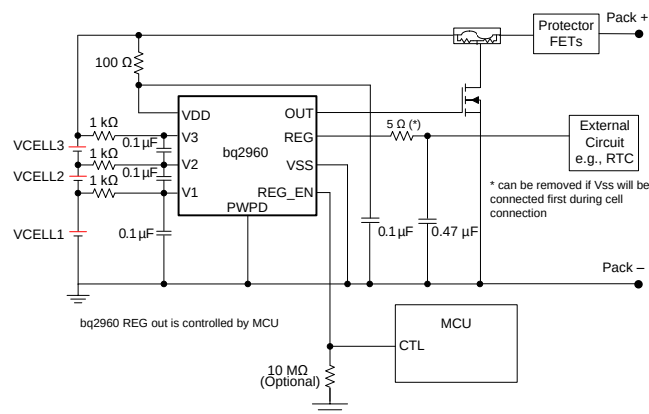
器件信息(1)(2)

器件编号	封装	封装尺寸 (标称值)
bq2960	WSON (8)	2.00mm x 2.00mm
bq2961		
bq2962		

(1) 要了解所有可用封装，请参阅数据表末尾的可订购产品附录。

(2) bq2960 是 2 节到 3 节电池器件。bq2961 和 bq2962 是 2 节到 4 节电池器件。

简化电路原理图



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4 修订历史记录

注：之前版本的页码可能与当前版本有所不同。

Changes from Revision C (October 2016) to Revision D	Page
在简化原理图中将器件标签从“bq2960xy”更改为“bq2960”，并将器件标签从“bq2961xy”更改为“bq2961/bq2962”	1
Separated bq2961 and bq2962 device options into two tables	4
Removed bq296100 preview status. Added bq296215, bq296216, bq296217 device spins to Device Comparison Table	4
Extended IDD test condition from $(V_n - V_{n-1}) = 3.8V$ to $(V_n - V_{n-1}) = 2V$ to 4.15V	7
Added VOUT TYP and MAX specification	7
Added VREG specification at 500 μA load. Was only specified with 0~1mA range before.	8
Extended IREG MAX specification to 2mA, was 1mA before	8
Changed device label from "bq2960xy" "bq2960" in Application Schematic	15
Corrected REG capaitor to 0.47 μF in the current consumption test circuit, was 0.1 μF	17
Changed device label from "bq2961xy" to "bq2961/bq2962" in reference schematic. Updated figure title to "bq2961 and bq2962 schematic", was "bq2961 schematic" before	19
Changed device label from "bq2960xy" to "bq2960" in reference schematic	21
Changed device label from "bq2961xy" to "bq2961/bq2962". Updated figure title to bq2961 and bq2962 schematic	22
已添加 接收文档更新通知部分	23

Changes from Revision B (May 2016) to Revision C	Page
已添加 bq2962 REG 选项	1
已更改 部件号改为 bq2960、bq2961、bq2962 以标识整个数据表中的每个分支系列	1
Added bq296202, bq296203, bq296212, bq296213	4
Added bq2962 pinout	5
Added bq2962 device to Recommended Operating Conditions	6
Extended bq2962 VREG full range condition from 0mA to 2mA, was 0mA to 1mA before	8
已添加 bq2962 regulator programmable option	11
已更改 figure title to apply to bq2962 family	19
已更改 figure title to apply to bq2962	22

Changes from Revision A (January 2016) to Revision B
Page

-
- Added bq296114 to [Device Comparison Table](#) 4
-

Changes from Original (November 2013) to Revision A
Page

-
- 将数据表标题信息中的器件列表更改为 bq2961 1
 - Changed bq296106, '107, '111 From: Preview To: Released status 4
 - Added bq296112 to [Device Comparison Table](#) 4
 - Added bq296113 to [Device Comparison Table](#) 4
 - Added Available the bq2961xy configuration range to [Device Comparison Table](#) 4
-

5 Device Comparison Table

Table 1. bq2962 Device Options

bq2962	OVP (V)	OVP DELAY (s)	UV (V)	LDO (V)
bq296202	4.45	6.5	2.5	3.3
bq296203	4.50	6.5	2.5	3.3
bq296212	4.50	3.0	2.5	3.3
bq296213	4.35	3.0	2.5	3.3
bq296215 ⁽¹⁾	4.50	6.5	2.5	3.0
bq296216	4.55	6.5	2.5	3.0
bq296217	4.55	6.5	2.8	3.3
bq2962	3.85V - 4.60V (50mV step)	3.0, 4.0, 5.5, 6.5	2.0V - 2.8V (50mV step)	3, 3.15, 3.3

(1) Product Preview only

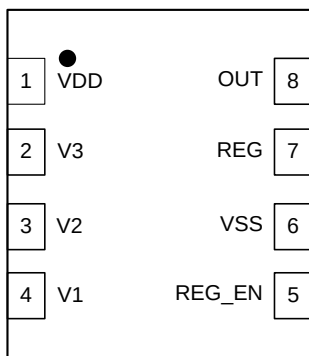
Table 2. bq2961 Device Options

bq2961	OVP (V)	OVP DELAY (s)	UV (V)	LDO (V)
bq296100	4.35	6.5	2.5	3.3
bq296101 ⁽¹⁾	4.40	6.5	2.5	3.3
bq296102 ⁽¹⁾	4.45	6.5	2.5	3.3
bq296103	4.50	6.5	2.5	3.3
bq296104 ⁽¹⁾	4.35	6.5	2.8	3.3
bq296105 ⁽¹⁾	4.40	6.5	2.8	3.3
bq296106	4.45	6.5	2.8	3.3
bq296107	4.50	6.5	2.8	3.3
bq296108 ⁽¹⁾	4.50	6.5	2.4	3.3
bq296109 ⁽¹⁾	4.325	3.0	2.5	3.3
bq296110 ⁽¹⁾	4.45	3.0	2.5	3.3
bq296111	4.45	4.0	2.5	3.3
bq296112	4.50	3.0	2.5	3.3
bq296113	4.35	3.0	2.5	3.3
bq296114	4.50	4.0	2.5	3.3
bq2961	3.85V - 4.60V (50mV step)	3.0, 4.0, 5.5, 6.5	2.0V - 2.8V (50mV step)	1.8, 2.5, 3.3

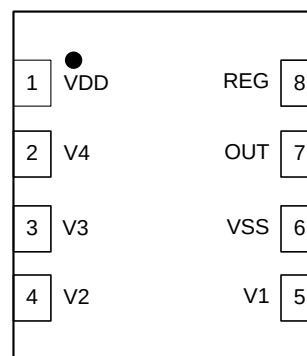
(1) Product Preview only

6 Pin Configuration and Functions

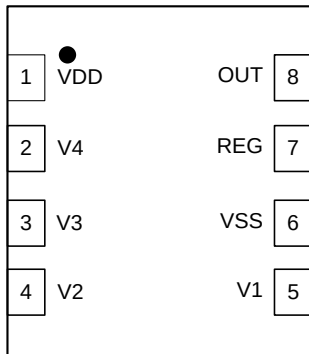
**2s-to-3s bq2960
(Top View)**



**2s-to-4s bq2962
(Top View)**



**2s-to-4s bq2961
(Top View)**



Pin Functions

PIN				TYPE ⁽¹⁾	DESCRIPTION
NAME	bq2960	bq2961	bq2962		
OUT	8	8	7	OA	Analog Output drive for overvoltage fault signal, CMOS Output High or Open Drain Active Low.
PWPD	9	9	9	P	TI recommends connecting the exposed pad to VSS on PCB.
REG	7	7	8	OA	Regulated Supply Output. Requires an external ceramic capacitor for stability.
REG_EN	5	—	—	IA	Regulated Supply Output Enable. A "high" to enable REG output and "low" to disable REG output.
V1	4	5	5	IA	Sense input for positive voltage of the lowest cell from the bottom of the stack.
V2	3	4	4	IA	Sense input for positive voltage of the second cell from the bottom of the stack.
V3	2	3	3	IA	Sense input for positive voltage of the third cell from the bottom of the stack.
V4	—	2	2	IA	Sense input for positive voltage of the fourth cell from the bottom of the stack.
VDD	1	1	1	P	Power supply input
VSS	6	6	6	P	Electrically connected to integrated circuit ground and negative terminal of the lowest cell in the stack.

(1) IA = Analog input, OA = Analog Output, P = Power connection

7 Specifications

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Supply voltage	VDD – VSS	–0.3	30	V
Input voltage	V4 – V3, V3 – V2, V2 – V1, V1 – VSS	–0.3	30	
	REG – VSS	–0.3	3.6	
	REG_EN – VSS	–0.3	28	
Output voltage	OUT – VSS	–0.3	30	
Continuous total power dissipation, P _{TOT}		See Thermal Information .		
Lead temperature (soldering, 10 s), T _{SOLDER}		300	300	°C
Storage temperature, T _{stg}		–65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under [Recommended Operating Procedures](#). Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

		VALUE	UNIT
V _(ESD) Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	2000	V
	Charged device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted).

		MIN	NOM	MAX	UNIT
Supply voltage, V _{DD} ⁽¹⁾	Supply voltage, V _{DD} ⁽¹⁾ , bq2960	3		15	V
	Supply voltage, V _{DD} ⁽¹⁾ , bq2961, bq2962	3		20	
	Supply voltage, V _{DD} with REG output on	4			
Input voltage range	V _n – V _{n-1} , V1 – VSS	0		5	V
	REG_EN	0		15	V
Operating ambient temperature range, T _A		–40		110	°C

- (1) See [Typical Application](#).

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		bq2960xy	UNIT
		DSG (WSON)	
		8 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	62	°C/W
R _{θJC(top)}	Junction-to-case(top) thermal resistance	72	°C/W
R _{θJB}	Junction-to-board thermal resistance	32.5	°C/W
ψ _{JT}	Junction-to-top characterization parameter	1.6	°C/W
ψ _{JB}	Junction-to-board characterization parameter	33	°C/W
R _{θJC(bot)}	Junction-to-case(bottom) thermal resistance	10	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Electrical Characteristics

Typical values stated where $T_A = 25^\circ\text{C}$ and $V_{DD} = 14.4\text{ V}$, MIN/MAX values stated where $T_A = -40^\circ\text{C}$ to $+110^\circ\text{C}$, and $V_{DD} = 3\text{ V}$ to 15 V (unless otherwise noted).

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
Voltage Protection Thresholds							
V _{OV}	V ^(PROTECT) Overvoltage Detection	R _{IN} = 1 kΩ		Applicable Voltage: 3.85 V to 4.6 V in 50 mV steps			V
V _{HYS}	OV Detection Hysteresis			250	300	400	mV
V _{OA}	OV Detection Accuracy	T _A = 25°C		−10		10	mV
V _{OADRIFT}	OV Detection Accuracy Across Temperature	T _A = −40°C		−40		40	mV
		T _A = 0°C		−20		20	mV
		T _A = 60°C		−24		24	mV
		T _A = 110°C		−54		54	mV
		T _A = 110°C		−54		54	mV
Supply and Leakage Current							
I _{DD}	Supply Current with REG on	(V _n − V _{n-1}) = 2 V to 4.15 V, n = 1 to 4, VDD = top V _n voltage (V1 − V _{SS}) > V _{UVREG} , I _{REG} = 0 mA,	T _A = 0°C to 60°C		4	6	μA
			T _A = −40°C to 110°C			8	μA
I _{DD}	Supply Current with REG off	(V _n − V _{n-1}) = 2 V to 4.15 V, n = 1 to 4, VDD = top V _n voltage (V1 − V _{SS}) < V _{UVREG}	T _A = 0°C to 60°C		1	2	μA
			T _A = −40°C to 110°C			4	μA
I _{IN}	Input Current at V _x Pins	(V _n − V _{n-1}) = (V1 − V _{SS}) = 3.8 V, VDD = top V _n voltage, T _A = 25°C		−0.1		0.1	μA
Output Drive OUT, CMOS Active High							
V _{OUT}	Output Drive Voltage, Active High	(V _n − V _{n-1}) or (V1 − V _{SS}) > V _{OV} , I _{OH} = 100 μA, VDD = top V _n voltage		6	7	8	V
		If three of four cells are short circuited, only one cell remains powered and > V _{OV} , VDD = V _n (the remaining cell voltage), I _{OH} = 100 μA			VDD − 0.3		V
		(V _n − V _{n-1}) and (V1 − V _{SS}) < V _{OV} , VDD = sum of the cell stack voltage, I _{OL} = 100 μA measured into OUT pin			250	400	mV
I _{OUTH}	OUT Source Current (during OV)	(V _n − V _{n-1}), (V3 − V2), or (V1 − V _{SS}) > V _{OV} , VDD = top V _n voltage, forced OUT = 0 V, measured out of OUT pin				4.5	mA
I _{OUTL}	OUT Sink Current (no OV)	(V _n − V _{n-1}) and (V1 − V _{SS}) < V _{OV} , VDD = top V _n voltage, forced OUT = VDD, measured into OUT pin. Pull-up resistor R _{PU} = 5 kΩ to VDD		0.5		14	mA
Internal Fixed Delay Timer							
t _{DELAY}	OV Delay Time ⁽¹⁾	Internal Fixed Delay, 3 second delay option		2.4	3	3.6	s
		Internal Fixed Delay, 4 second delay option		3.2	4	4.8	s
		Internal Fixed Delay, 5.5 second delay option		4.4	5.5	6.6	s
		Internal Fixed Delay, 6.5 second delay option		5.2	6.5	7.8	s
t _{DELAY_CTM}	Fault Detection Delay Time in Test Mode OV Delay Time	Internal Fixed delay			15		ms

(1) Specified by design. Not 100% tested in production.

Electrical Characteristics (continued)

Typical values stated where $T_A = 25^\circ\text{C}$ and $V_{DD} = 14.4\text{ V}$, MIN/MAX values stated where $T_A = -40^\circ\text{C}$ to $+110^\circ\text{C}$, and $V_{DD} = 3\text{ V}$ to 15 V (unless otherwise noted).

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT	
Regulated Supply Output, REG							
V _{REG}	REG Supply at 500 μA load	V _{DD} ≥ 4 V, I _{REG} = 500 μA, C _{REG} = 0.47 μF	V _{REG} = 3.3 V , bq2960, bq2961, bq2962	3.234	3.300	3.366	V
			V _{REG} = 3.15 V , bq2962	3.087	3.150	3.213	
			V _{REG} = 3.0 V , bq2962	2.940	3.000	3.060	
			V _{REG} = 2.5 V , bq2960, bq2961	2.450	2.500	2.550	
			V _{REG} = 1.8 V , bq2960, bq2961	1.764	1.800	1.836	
V _{REG}	REG Supply from 0 to 2 mA load	V _{DD} ≥ 4 V, I _{REG} = 0 μA to 2 mA, C _{REG} = 0.47 μF	V _{REG} = 3.3 V , bq2960, bq2961, bq2962	3.200	3.300	3.400	V
			V _{REG} = 3.15 V , bq2962	3.050	3.150	3.250	
			V _{REG} = 3.0 V , bq2962	2.900	3.000	3.100	
			V _{REG} = 2.5 V , bq2960, bq2961	2.425	2.500	2.575	
			V _{REG} = 1.8 V , bq2960, bq2961	1.746	1.800	1.854	
I _{REG}	REG Current Output	V _{DD} ≥ 4 V, C _{REG} = 0.47 μF	0		2	mA	
I _{REG_SC_Limit}	REG Output Short Circuit Current Limit	REG = V _{SS} , C _{REG} = 0.47 μF	4			mA	
R _{REG_PD}	REG pull-down resistor	REG is disabled	20	30	45	kΩ	
Regulated Supply Output Enable, REG_EN							
V _{IH}	High-level Input		1.6			V	
V _{IL}	Low-level Input				0.4	V	
I _{LKG}	Input Leakage Current	V _{IH} < 6 V			0.1	μA	
Regulated Supply Undervoltage Self-disable							
V _{UVREG}	Undervoltage detection	Factory Configuration: 2.0 V to 2.8 V in 50 mV steps, T _A = 25 °C	–50		50	mV	
V _{UVHYS}	Undervoltage Detection Hysteresis		250	300	400	mV	
t _{UVDELAY}	Undervoltage Detection Delay		4.5	6	7.5	s	
V _{UVQUAL}	Cell voltage to qualify for UV detection			0.5		V	

7.6 Typical Characteristics

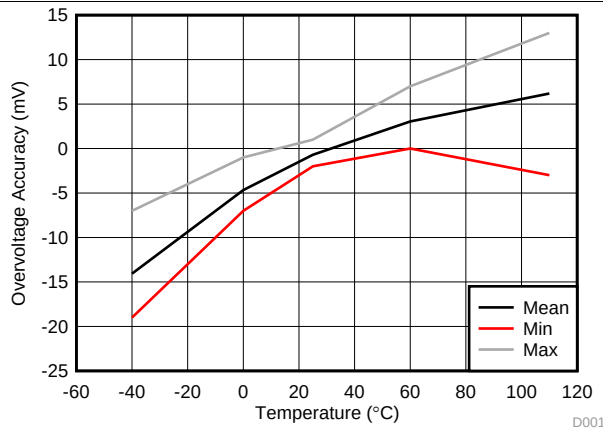


图 1. Overvoltage Threshold (V_{OV}) vs Temperature

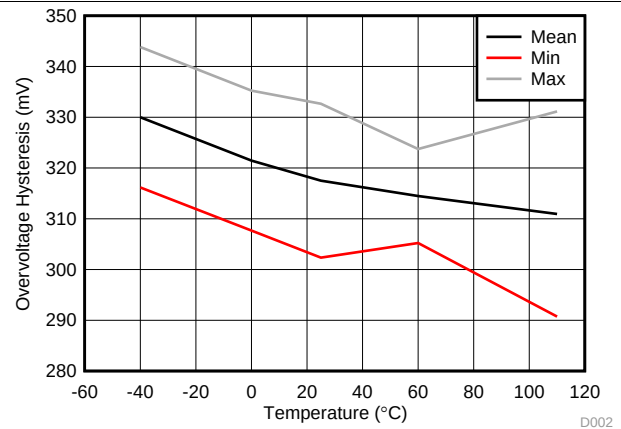


图 2. Hysteresis V_{HYS} vs Temperature

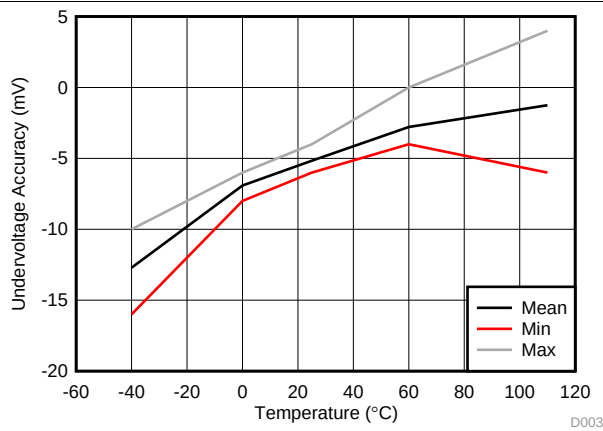


图 3. Undervoltage Accuracy

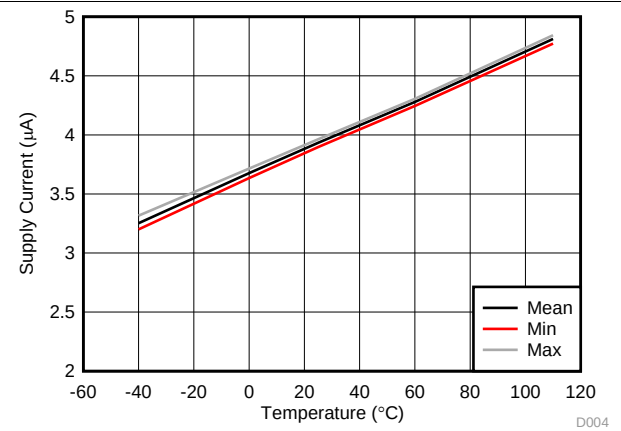


图 4. I_{DD} with Regulator On

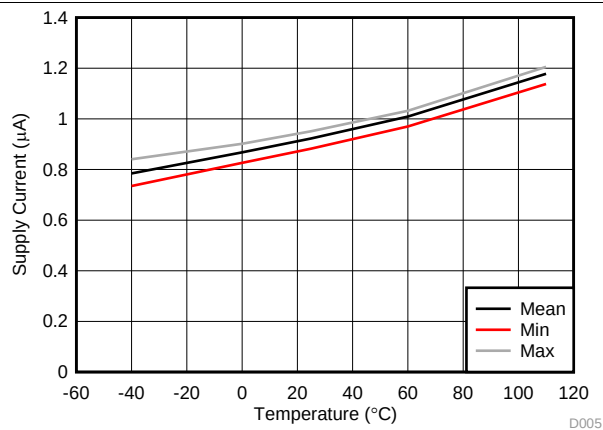


图 5. I_{DD} with Regulator Off

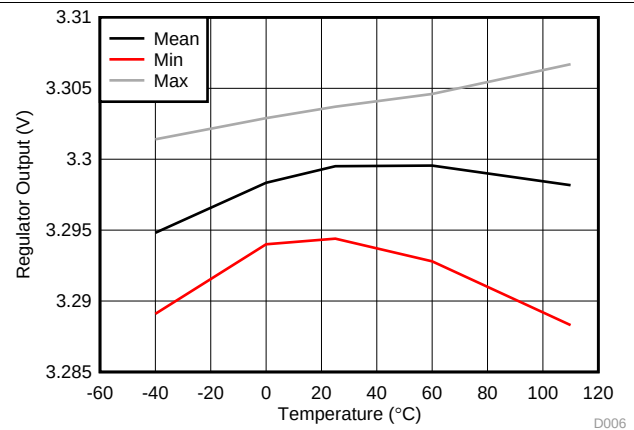


图 6. Regulator Output Without Load

Typical Characteristics (接下页)

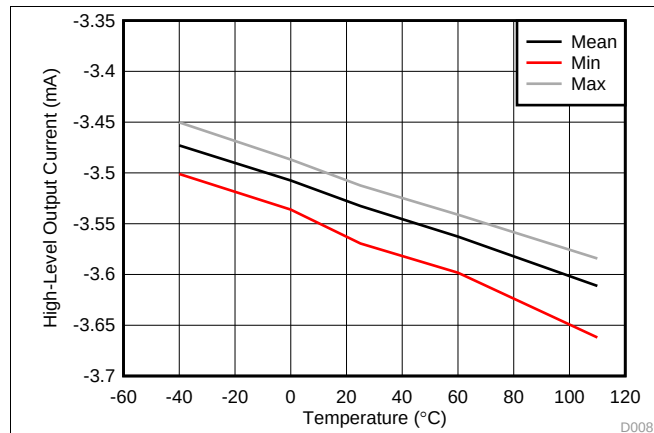


图 7. I_{OUTH} vs Temperature

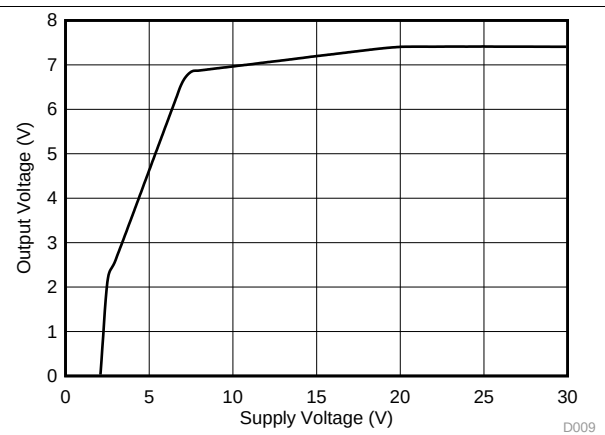


图 8. V_{OUT} vs V_{DD}

8 Detailed Description

8.1 Overview

The bq2960, bq2961 and bq2962 are second-level overvoltage (OV) protectors with a regulated output. Each cell is monitored independently by comparing the actual cell voltage to an overvoltage threshold V_{OV} . The overvoltage threshold is preprogrammed at the factory with a range between 3.85 V to 4.65 V.

The regulated output is enabled unless any of the cell voltages fall below the V_{UVREG} threshold. This threshold is preprogrammed at the factory with a range between 2 V to 2.8 V. For bq2960xy family, an external control pin, REG_EN, is available to enable or disable the regulated output in addition to the V_{UVREG} detection.

表 3. Programmable Parameters

OVERVOLTAGE RANGE (V)	OVERVOLTAGE DELAY (s)	UNDERVOLTAGE RANGE (V)	REGULATOR (V)
3.85 to 4.6 in 50 mV step	3, 4, 5.5, 6.5	2.0 to 2.8 in 50 mV step	1.8, 2.5, 3.3 (bq2960, bq2961) 3.0, 3.15, 3.3 (bq2962)

8.2 Functional Block Diagram

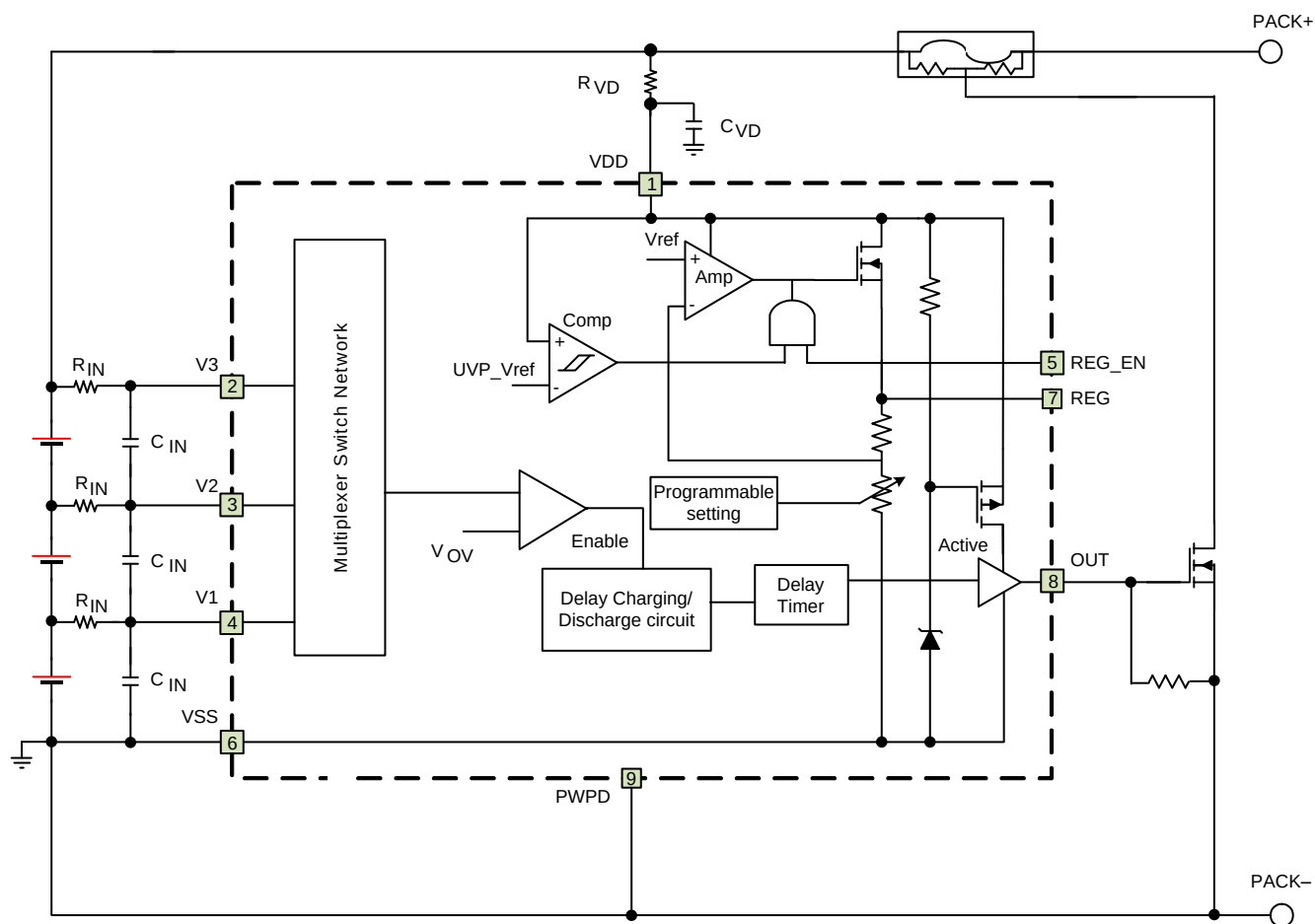
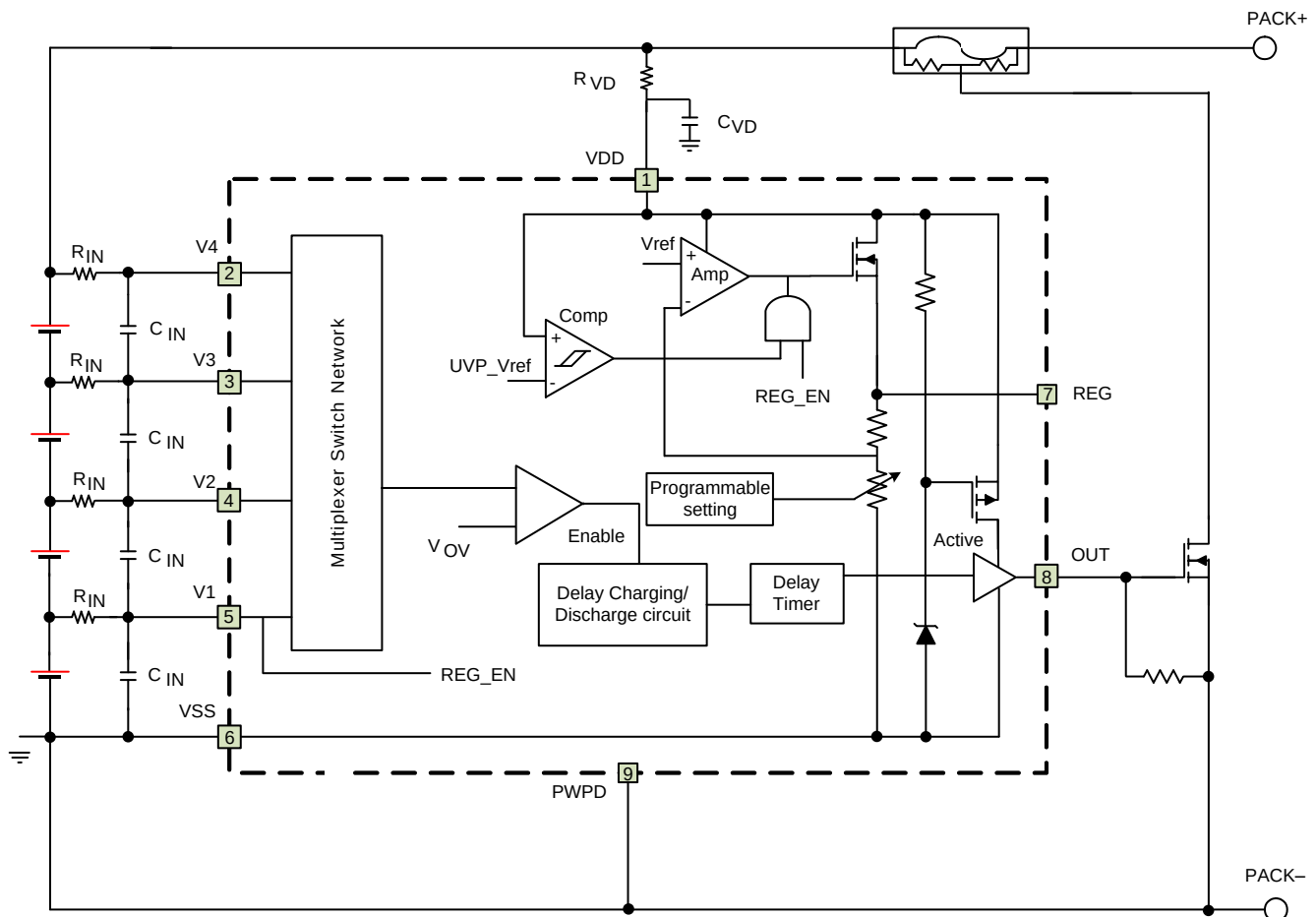


图 9. bq2960 Block Diagram

Functional Block Diagram (接下页)

图 10. bq2961 and bq2962 Block Diagram

8.3 Feature Description

8.3.1 Pin Details

8.3.1.1 Input Sense Voltage, V_x

These inputs sense each battery cell voltage. A series resistor and a capacitor across the cell for each input is required for noise filtering and stable voltage monitoring.

8.3.1.2 Output Drive, *OUT*

This terminal serves as the fault signal output in Active High.

8.3.1.3 Supply Input, *VDD*

This terminal is the unregulated input power source for the device. A series resistor is connected to limit the current, and a capacitor is connected to ground for noise filtering.

8.3.1.4 Regulated Supply Output, *REG*

This terminal is connected to an external capacitor and provides a regulated supply to power a circuit such as a Real Time Clock integrated circuit, or functions requiring a well-regulated supply. Maximum current load on this pin cannot exceed 1 mA.

Feature Description (接下页)

The REG output has protection for overcurrent, using a current limit protection circuit, and also detects and protects for excessive power dissipation due to short circuit of the external load. This pin requires a ceramic 1- μ F capacitor connection to VSS for improved stability, noise immunity, and ESD performance of the supply output. This capacitor must be placed close to the REG and VSS pins for connection.

8.3.1.5 Regulated Supply Output Enable, REG_EN (bq2960 Only)

This terminal is a high voltage input drain to enable and disable the regulated supply output, REG terminal. When the VREG_EN > V_{IH} , the REG terminal output is enabled including the cell undervoltage detection function to self-disable the regulated supply. When the VREG_EN < V_{IL} , the REG terminal output, the cell undervoltage detection and the regulated supply self-disable functions are disabled.

To keep the REG output enabled at all times, the recommendation is to connect the REG_EN to the V1 termination. There is a 6-V clamp to protect the REG_EN terminal from a high voltage input. By connecting REG_EN to V1, the clamp circuit is not active.

When the REG output is enabled, VREG_EN > V_{IH} , the REG output can be self-disabled if any of the cell voltages are < V_{UVREG} . The self-disable function is used to reduce power consumption when the battery pack is deeply depleted.

8.3.2 Overvoltage Sensing for OUT

In the bq296xxx device, each cell is monitored independently. Overvoltage is detected by comparing the actual cell voltage to a protection voltage reference, V_{OV} . If any cell voltage exceeds the programmed OV value, an internal timer circuit is activated. This timer circuit causes a factory pre-programmed fixed delay before the OUT terminal goes from inactive to active state.

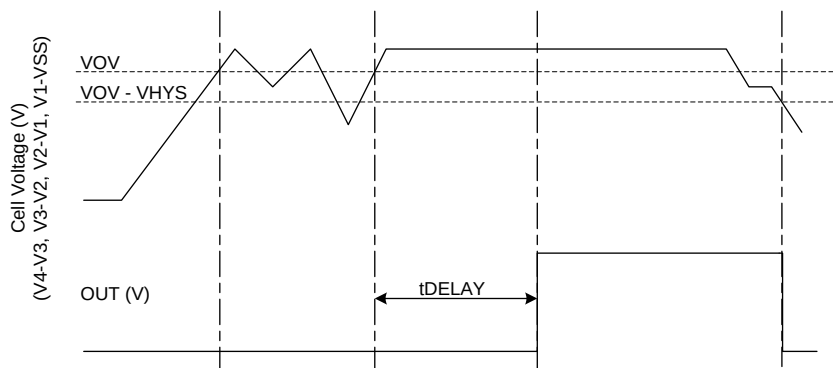


图 11. Timing for Overvoltage Sensing for OUT

8.3.3 Regulated Output Voltage and REG_EN Pin

For bq2960 and bq2961, there are three factory-preprogrammed options for the regulated output voltage, 3.3 V, 2.5 V, and 1.8 V. For bq2962, the regulated output voltage options are 3.3 V, 3.15 V, and 3.0 V. bq2962xy can potentially provide other regulated voltage output between 3.3 V to 3.0 V, contact Texas Instruments for detail.

At power up, the regulated output is on by default. If any cell voltage is below V_{UVREG} at device power up, the regulated output will remain on until the t_{UV_DELAY} time has passed, the regulated out turns off after the delay time.

During discharge, if any cell voltage falls below the V_{UVREG} threshold for t_{UV_DELAY} time, the regulated output is self-disabled. The regulated output turns on again when all the cell voltages are above $V_{UVREG} + V_{UVHYS}$.

Feature Description (接下页)

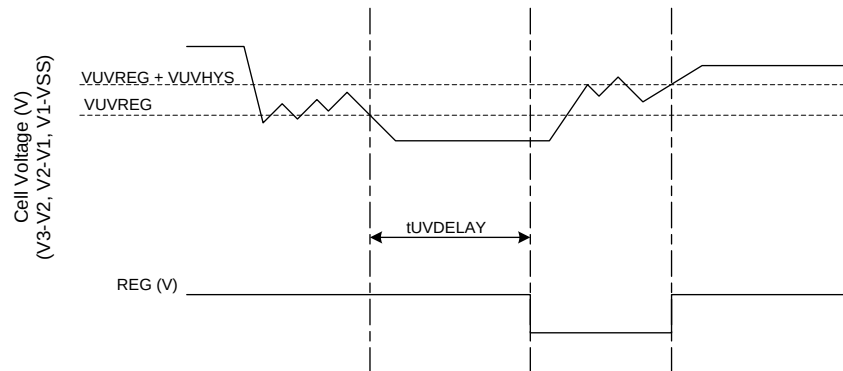
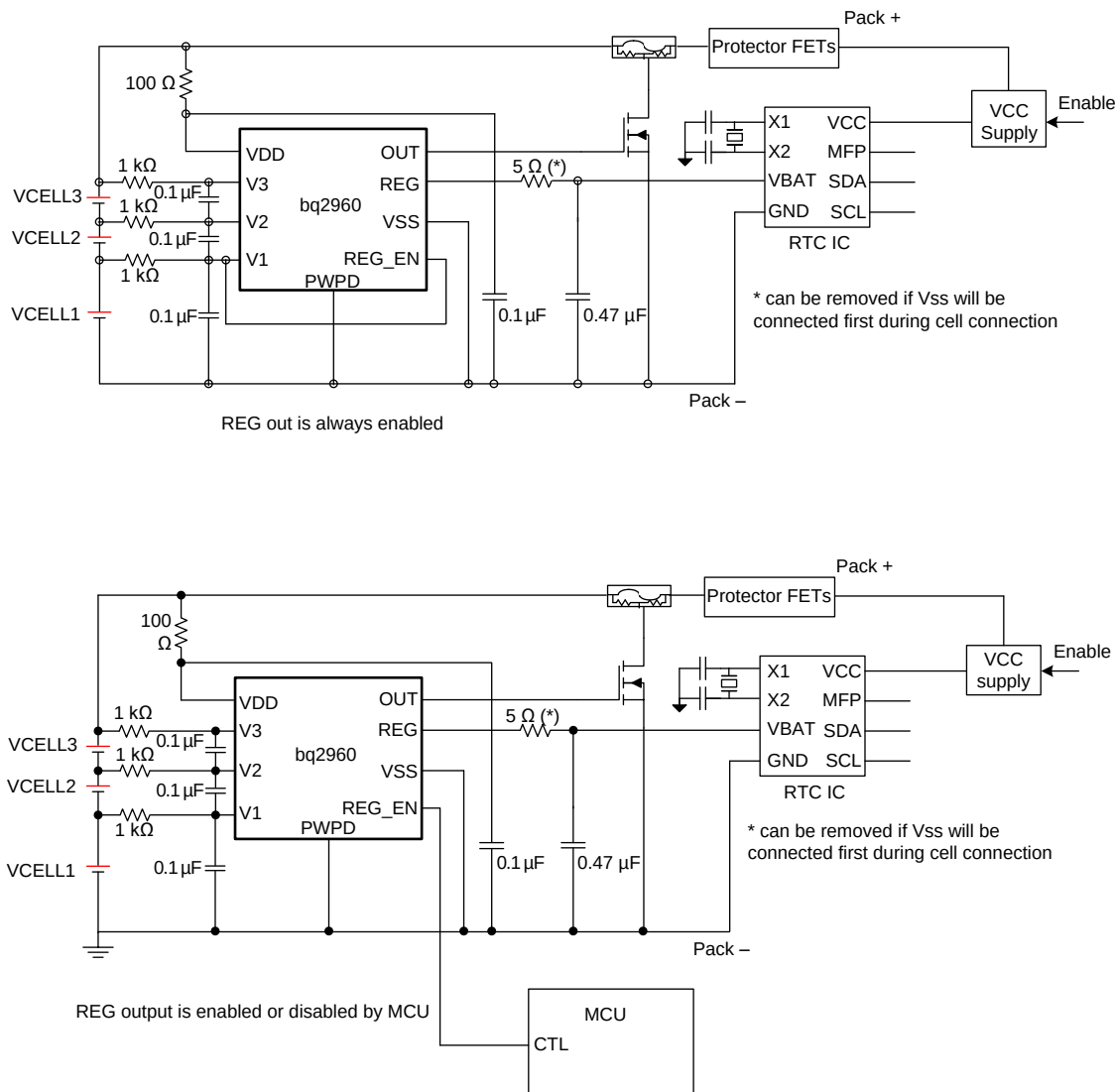


图 12. REG Output Timing

For bq2960 family, an external REG_EN pin is available to enable and disable the regulated output function. To enable both the regulated output and the undervoltage self-disable features, the REG_EN pin must be above V_{IH} . A microcontroller can be used to control the REG_EN pin. Alternatively, connecting the REG_EN pin to the bottom cell is another option to enable the regulated output function always.

Feature Description (接下页)



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图 13. bq2960 Application Schematic

8.4 Device Functional Modes

8.4.1 NORMAL Mode

When all of the cell voltages are below the V_{OV} threshold AND above V_{UVREG} threshold, the device operates in NORMAL mode. The device monitors the differential cell voltages connected across (V1–VSS), (V2–V1), (V3–V2), and (V4–V3). The OUT pin is inactive in this mode. The regulated output is always enabled for bq2961. For bq2960, the regulated output is on only if the voltage on the REG_EN pin is above V_{IH} .

Device Functional Modes (接下页)

8.4.2 OVERVOLTAGE Mode

OVERVOLTAGE mode is detected if any of the cell voltages exceed the overvoltage threshold, V_{OV} , for configured OV delay time. The OUT pin is activated after a delay time preprogrammed at the factory. The OUT pin will pull high internally. Then an external FET is turned on, shorting the fuse to ground, which allows the battery and/or charger power to blow the fuse. When all of the cell voltages fall below $(V_{OV} - V_{HYS})$, the device returns to NORMAL mode. The regulated output (if enabled) remains on in this mode.

8.4.3 UNDERVOLTAGE Mode

The UNDERVOLTAGE mode is detected if any of the cell voltage across $(V1-VSS)$, $(V2-V1)$, $(V3-V2)$, or $(V4-V3)$ is below the V_{UVREG} threshold for t_{UV_DELAY} time. In this mode, the regulated output is disabled. To return to the NORMAL mode, all the cell voltages must be above $(V_{UVREG} + V_{UVHYS})$.

For a low cell configuration, V_n pin can be shorted to the $(V_n - 1)$ pin. The device ignores any differential cell voltage below V_{UVQUAL} threshold for undervoltage detection.

8.4.4 CUSTOMER TEST MODE

The Customer Test Mode (CTM) helps to reduce test time for checking the overvoltage delay-timer parameter once the circuit is implemented into the battery pack. To enter CTM, the VDD pin should be set at least 10 V higher than V3 (see 图 14). The delay timer is greater than 10 ms, but considerably shorter than the timer delay in normal operation. To exit CTM, remove the VDD to VC3 voltage differential of 10 V, so that the decrease in the value automatically causes an exit.

CAUTION

Avoid exceeding any Absolute Maximum Voltages on any pins when placing the device into CTM. Also avoid exceeding Absolute Maximum Voltages for the individual cell voltages $(V3-V2)$, $(V2-V1)$ and $(V1-VSS)$. Stressing the pins beyond the rated limits can cause permanent damage to the device.

图 14 shows the timing for the Customer Test Mode.

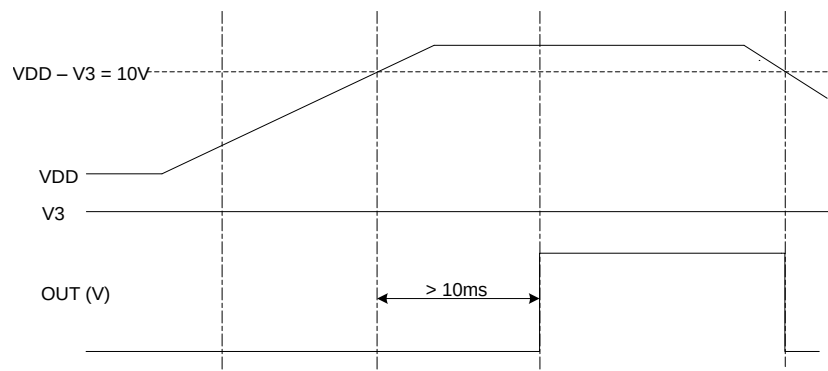


图 14. Timing for Customer Test Mode

Device Functional Modes (接下页)

图 15 shows the measurement for current consumption of the product for both VDD and Vx.

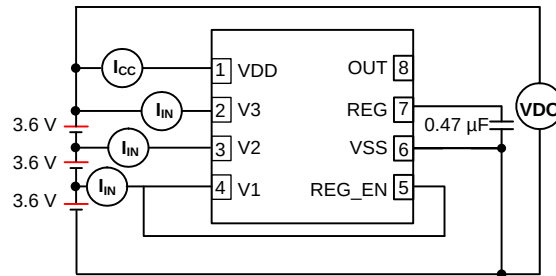


图 15. Configuration for Integrated Circuit Current Consumption Test

9 Application and Implementation

注

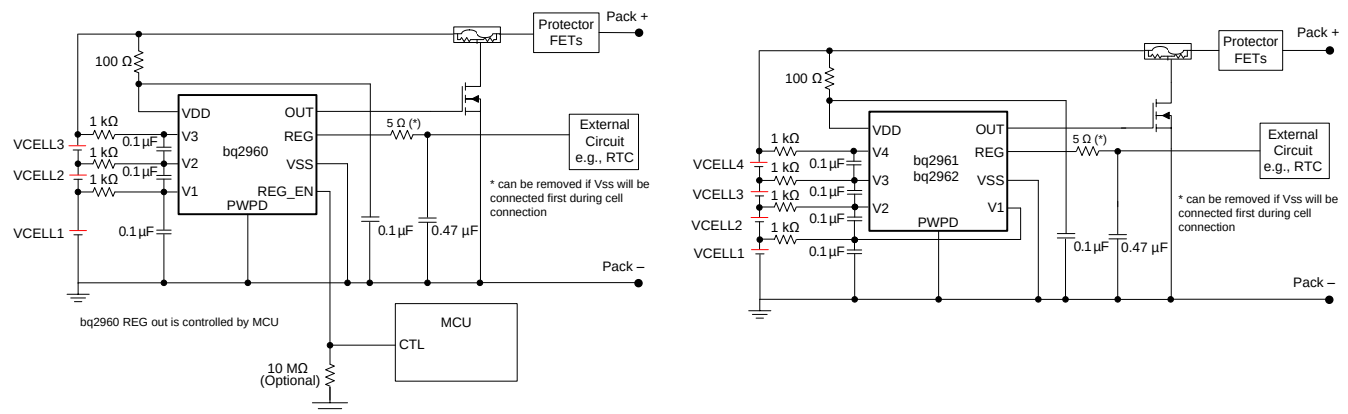
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The bq296xxx is a family of second-level protectors used for overvoltage protection of the battery pack in the application. A regulated output is available to drive a small circuit with maximum I_{REG} loading. The device OUT pin is active high, which drives a NMOS FET that connects the fuse to ground in the event of a fault condition. This provides a shorted path to use the battery and/or charger power to blow the fuse and cut the power path.

9.2 Typical Application

图 13 shows the recommended reference design components.



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图 16. Application Schematic

9.2.1 Design Requirements

注

Changes to the ranges stated in 表 4 will impact the accuracy of the cell measurements.

表 4. Parameters

PARAMETER	EXTERNAL COMPONENT	MIN	NOM	MAX	UNIT
Voltage monitor filter resistance	R_{IN}	900	1000	4700	Ω
Voltage monitor filter capacitance	C_{IN}	0.01	0.1	1.0	μF
Supply voltage filter resistance	R_{VD}	0.1	—	1	$K\Omega$
Supply voltage filter capacitance	C_{VD}	—	0.1	1.0	μF
REG output capacitance	C_{REG}	0.47	1	—	μF

注

The device is calibrated using an R_{IN} value = 1 k Ω . Using a value other than the recommended value changes the accuracy of the cell voltage measurements and V_{OV} trigger level.

9.2.2 Detailed Design Procedure

注

The device VSS must be connected first during PCB test or cell attachment. Failure to do so can damage the REG pin.

1. If VSS pin cannot be connected first, it is required to add a resistor of a minimum of 5 ohms to a maximum of 10 ohms (a 5-ohm resistor is used in the reference schematic, 图 17) in series with the REG capacitor. When VSS is floating, the REG capacitor always charges up to the VDD voltage. When VSS is finally connected, the REG capacitor will be discharged. Adding a small resistor in series reduces the current strength and avoids any potential damage to the REG pin. The 5-ohm resistor can be placed in series with the REG connect circuit (as shown in 图 17) or in series of the REG capacitor (as shown in 图 18). Placing the resistor in series with the REG circuit results in a small drop of VREG (for example: max loading of 1 mA with a 5-ohm resistor will drop 5 mV on VREG), but such a connection can protect again rush current discharge from both REG capacitor or external filter capacitor connected to the REG pin. Placing the resistor in series with the REG capacitor is an alternative to avoid additional drop in VREG if the filter capacitor used by the external circuit is much smaller than the REG capacitor.
2. After VSS is connected, the device allows random cell connect to the Vx pin.
3. Cell should be connected to the lower V_n pin; the unused V_n pin should be shorted to the (V_{n-1}) pin. See 图 17 for details.

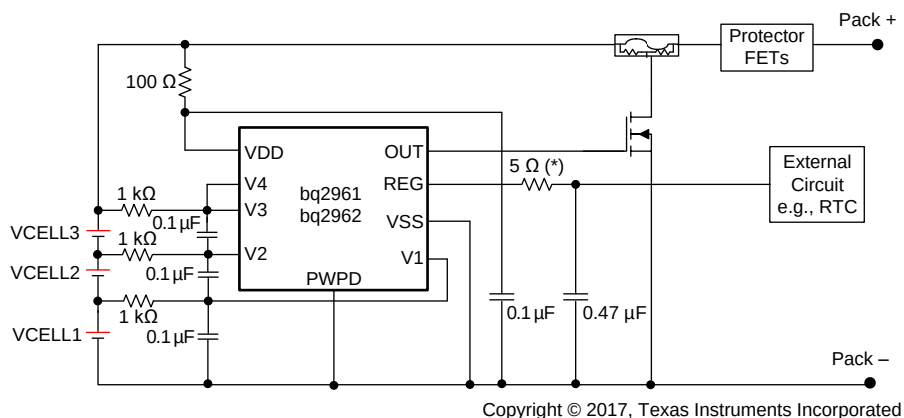


图 17. 3-Series bq2961 and bq2962 Schematic

4. A zener diode can be added to the REG pin to VSS as shown in 图 18. This is recommended to protect the circuit connected to the REG pin if floating VSS in the field is a risk concern. When VSS is floating (during cell connection when VSS is not connected first or in system fault with BAT– wire broken), the REG voltage always pulls up to VDD. In a 4-S configuration, the REG voltage can reach approximately 16 V with VSS floating. Adding a zener diode clamps the REG voltage to a safe level for the external circuits connected to the REG pin. Having the zener diode can also protect the external circuits if REG pin is shorted to OUT pin or any other high-voltage output terminal. If a zener diode is used, TI recommends putting the diode on the battery side with the bq296xxx device to allow protection on both the REG pin as well as the circuit connected to REG under floating VSS condition. The resistor in series with the REG pin is not required in this case.

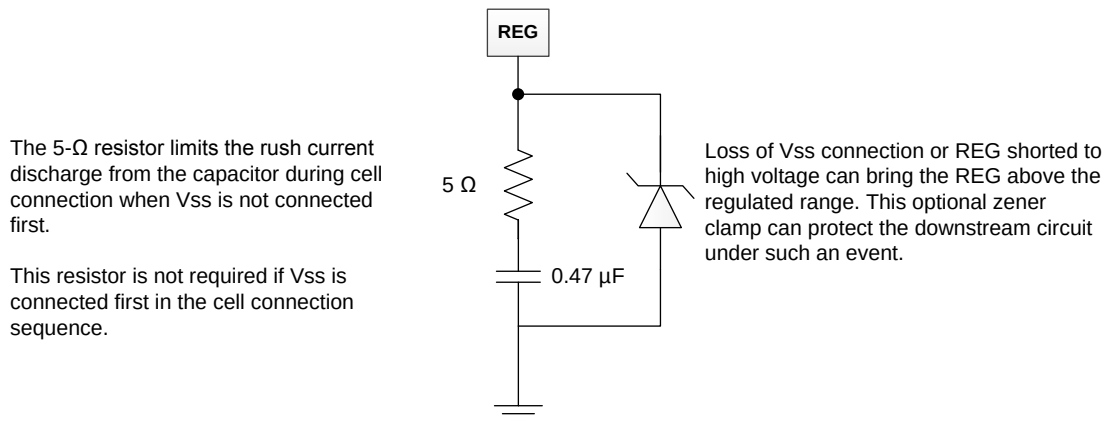


图 18. 5-V Zener Diode

5. For 2- to 3-series applications, if an external control for the regulated output is required, select the bq2960xy family. Otherwise, select the bq2961xy family.

9.2.3 Application Curves

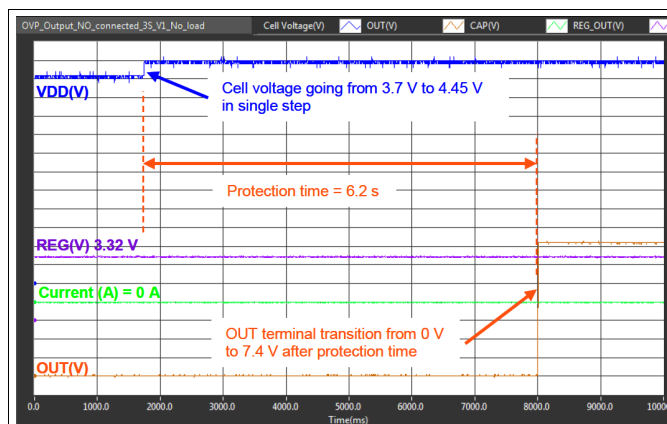


图 19. Overvoltage Protection

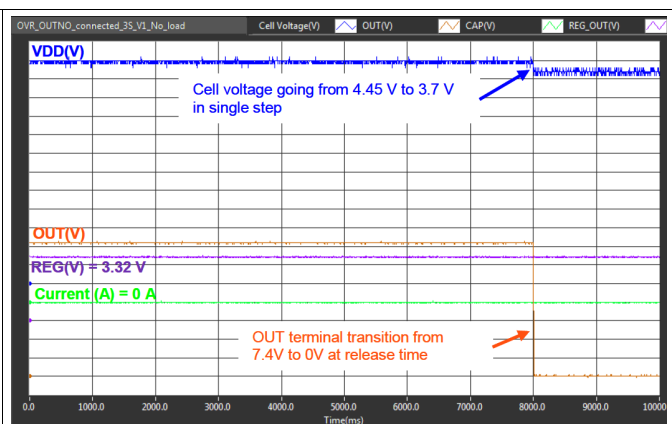


图 20. Overvoltage Protection Release

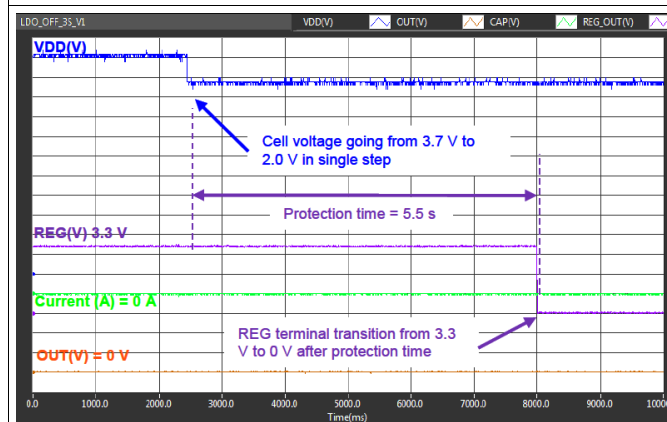


图 21. Undervoltage Detection to Turn off Regulator

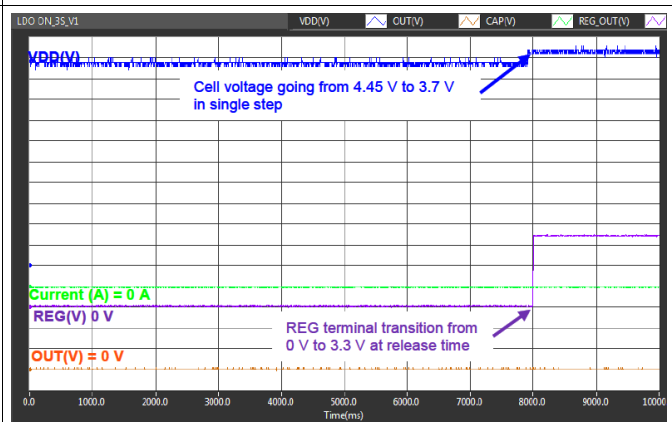
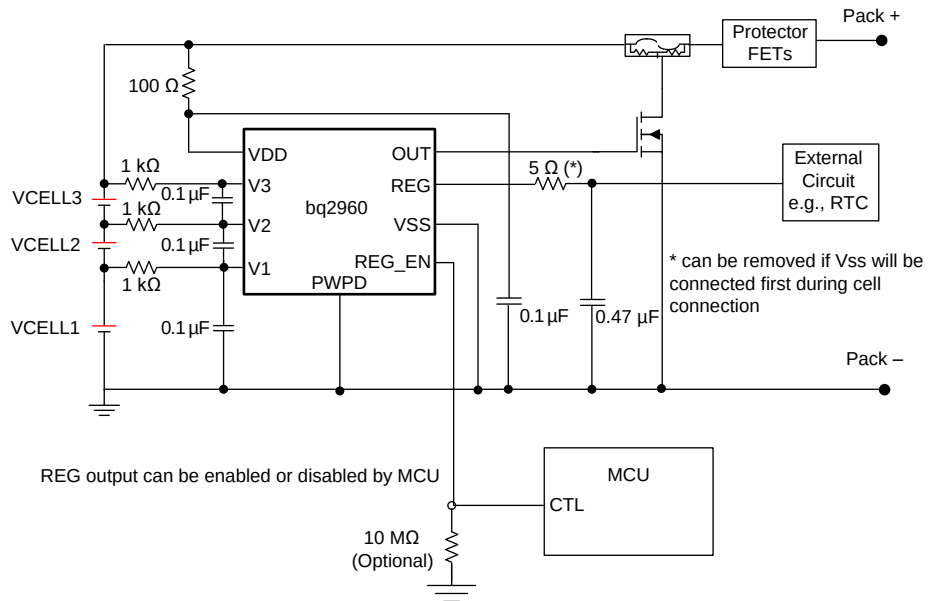
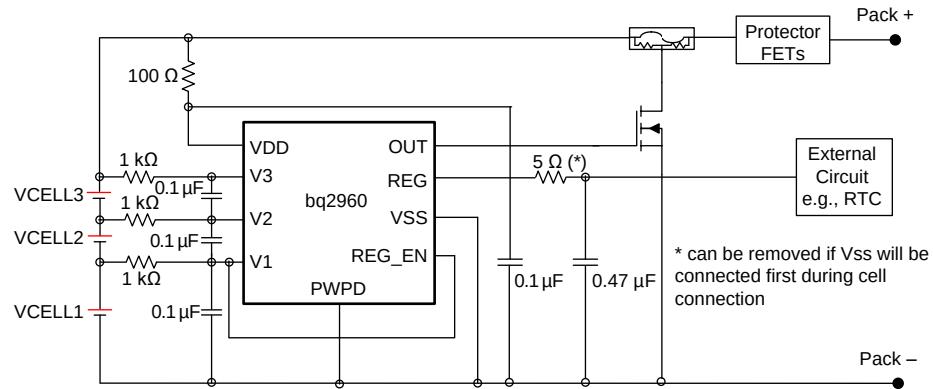


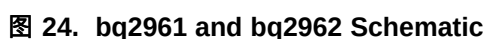
图 22. Undervoltage Release to Switch on Regulator

9.2.4 Other Schematics



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图 23. bq2960 Schematic with REG Output Always Enabled



12 器件和文档支持

12.1 接收文档更新通知

如需接收文档更新通知，请访问 www.ti.com.cn 网站上的器件产品文件夹。点击右上角的提醒我 (Alert me) 注册后，即可每周定期收到已更改的产品信息。有关更改的详细信息，请查阅已修订文档中包含的修订历史记录。

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Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

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ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

12.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
BQ296100DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6100	Samples
BQ296100DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6100	Samples
BQ296103DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6103	Samples
BQ296103DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6103	Samples
BQ296106DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6106	Samples
BQ296106DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6106	Samples
BQ296107DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6107	Samples
BQ296107DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6107	Samples
BQ296111DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6111	Samples
BQ296111DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6111	Samples
BQ296112DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6112	Samples
BQ296112DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6112	Samples
BQ296113DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6113	Samples
BQ296113DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6113	Samples
BQ296114DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6114	Samples
BQ296114DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6114	Samples
BQ296202DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6202	Samples
BQ296202DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6202	Samples
BQ296203DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6203	Samples
BQ296203DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6203	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
BQ296212DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6212	Samples
BQ296212DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6212	Samples
BQ296213DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6213	Samples
BQ296213DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6213	Samples
BQ296215DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6215	Samples
BQ296215DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6215	Samples
BQ296216DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6216	Samples
BQ296216DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6216	Samples
BQ296217DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6217	Samples
BQ296217DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6217	Samples
BQ296221DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6221	Samples
BQ296221DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6221	Samples
BQ296222DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6222	Samples
BQ296222DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6222	Samples
BQ296223DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6223	Samples
BQ296223DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6223	Samples
BQ296224DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6224	Samples
BQ296224DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6224	Samples
BQ296226DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6226	Samples
BQ296226DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6226	Samples
BQ296228DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6228	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
BQ296228DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6228	Samples
BQ296229DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6229	Samples
BQ296229DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6229	Samples
BQ296230DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6230	Samples
BQ296230DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6230	Samples
BQ296231DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6231	Samples
BQ296231DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6231	Samples
BQ296232DSGR	ACTIVE	WSO	DSG	8	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6232	Samples
BQ296232DSGT	ACTIVE	WSO	DSG	8	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 110	6232	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

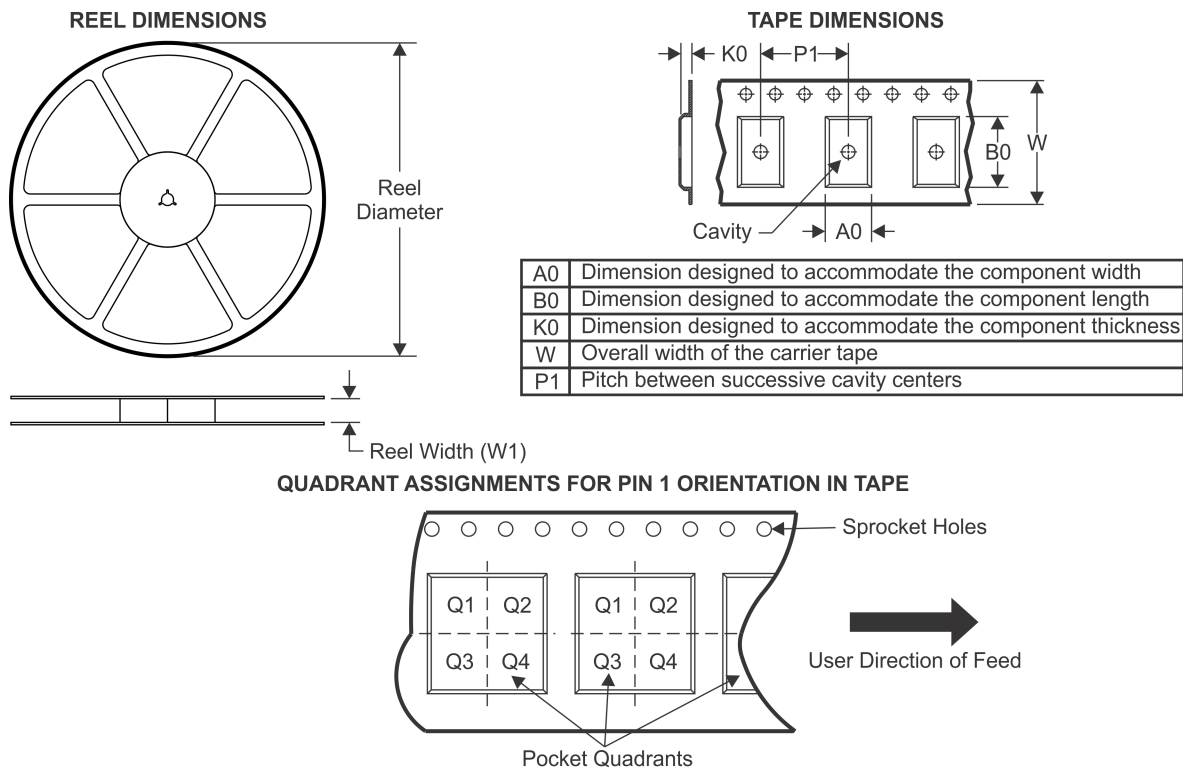
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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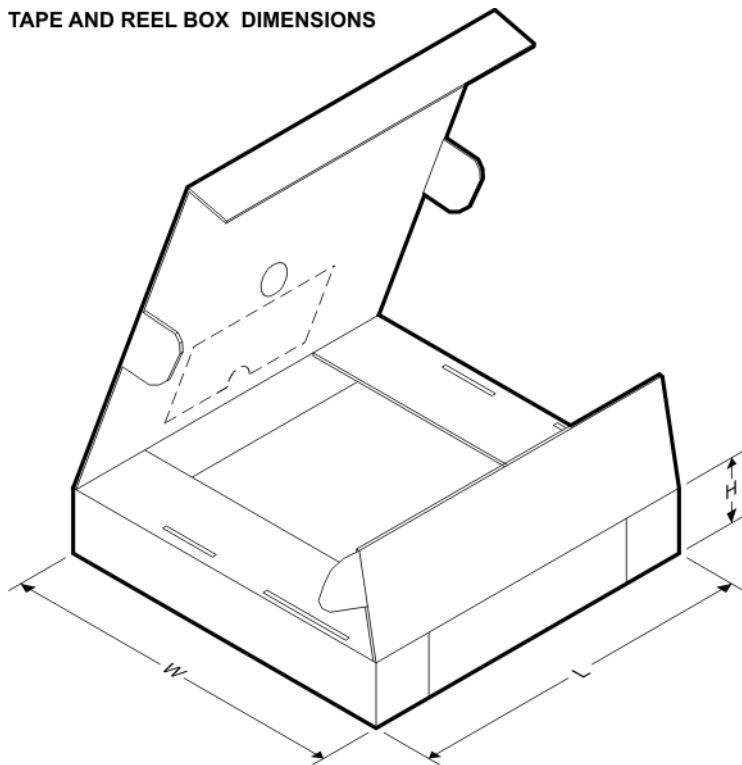
TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
BQ296100DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296100DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296103DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296103DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296106DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296106DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296107DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296107DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296111DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296111DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296112DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296112DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296113DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296113DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296114DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296114DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296202DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296202DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
BQ296203DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296203DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296212DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296212DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296213DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296213DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296215DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296215DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296216DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296216DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296217DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296217DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q2
BQ296221DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296221DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296222DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296222DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296223DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296223DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296224DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296224DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296226DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296226DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296228DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296228DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296229DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296229DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296230DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296230DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296231DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296231DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296232DSGR	WSO	DSG	8	3000	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3
BQ296232DSGT	WSO	DSG	8	250	180.0	8.4	2.3	2.3	1.15	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
BQ296100DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296100DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296103DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296103DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296106DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296106DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296107DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296107DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296111DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296111DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296112DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296112DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296113DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296113DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296114DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296114DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296202DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296202DSGT	WSN	DSG	8	250	210.0	185.0	35.0
BQ296203DSGR	WSN	DSG	8	3000	210.0	185.0	35.0
BQ296203DSGT	WSN	DSG	8	250	210.0	185.0	35.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
BQ296212DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296212DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296213DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296213DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296215DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296215DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296216DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296216DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296217DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296217DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296221DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296221DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296222DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296222DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296223DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296223DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296224DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296224DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296226DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296226DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296228DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296228DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296229DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296229DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296230DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296230DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296231DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296231DSGT	WSON	DSG	8	250	210.0	185.0	35.0
BQ296232DSGR	WSON	DSG	8	3000	210.0	185.0	35.0
BQ296232DSGT	WSON	DSG	8	250	210.0	185.0	35.0

GENERIC PACKAGE VIEW

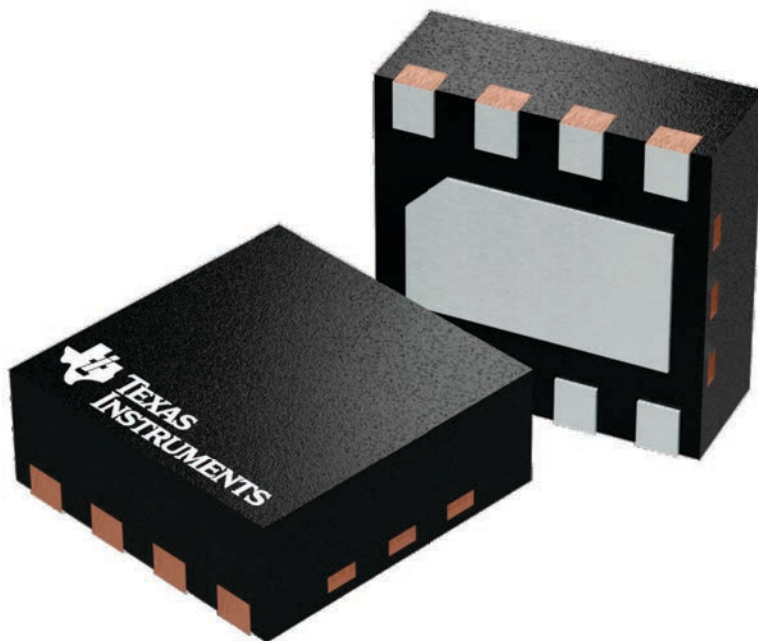
DSG 8

WSON - 0.8 mm max height

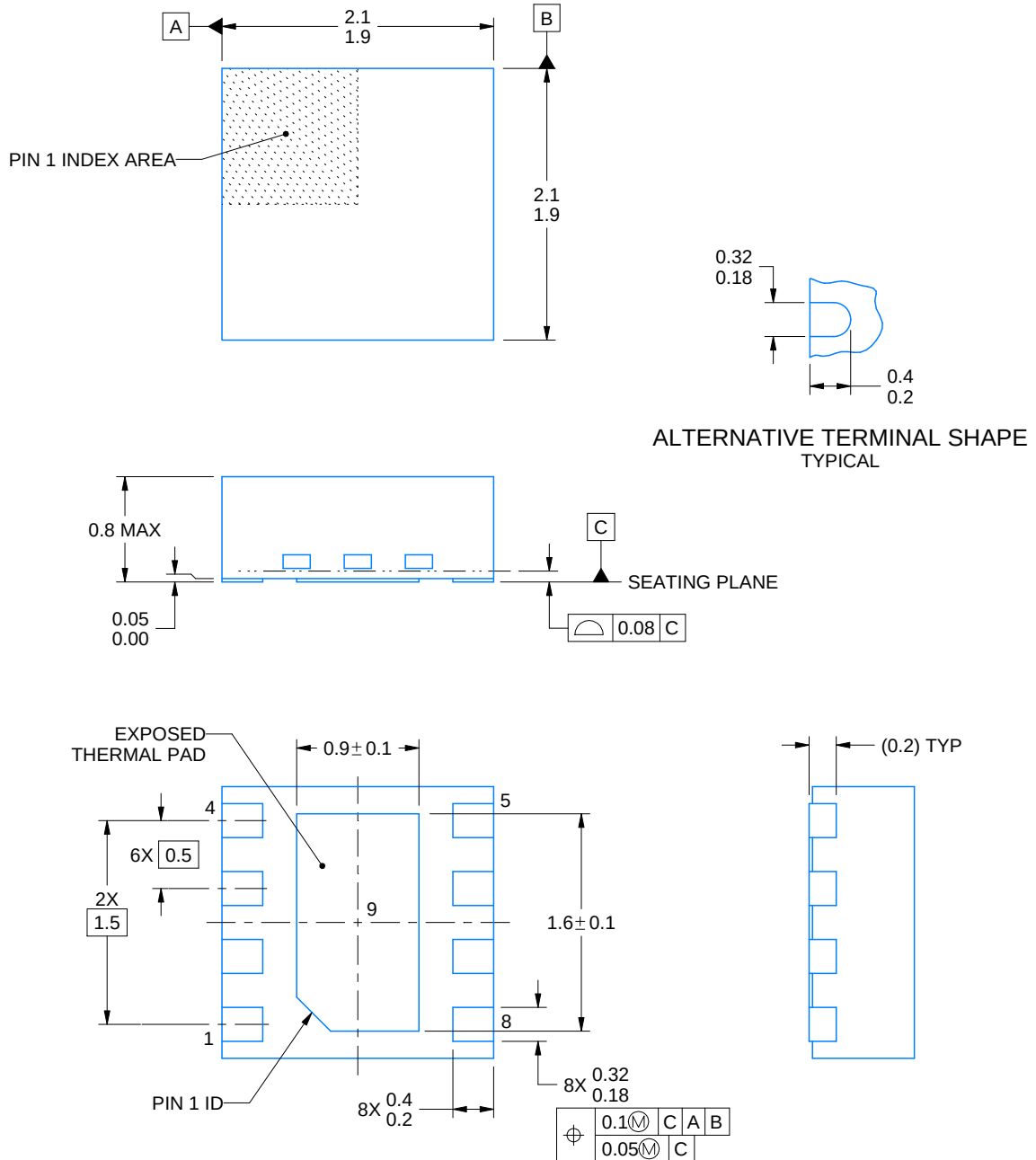
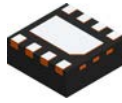
2 x 2, 0.5 mm pitch

PLASTIC SMALL OUTLINE - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4224783/A



4218900/D 04/2020

NOTES:

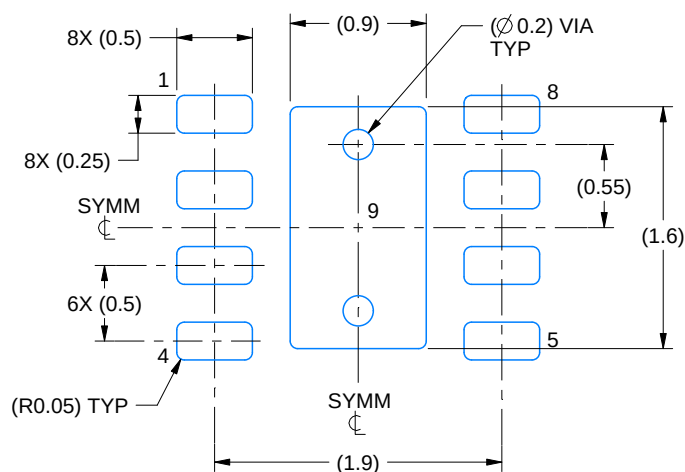
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

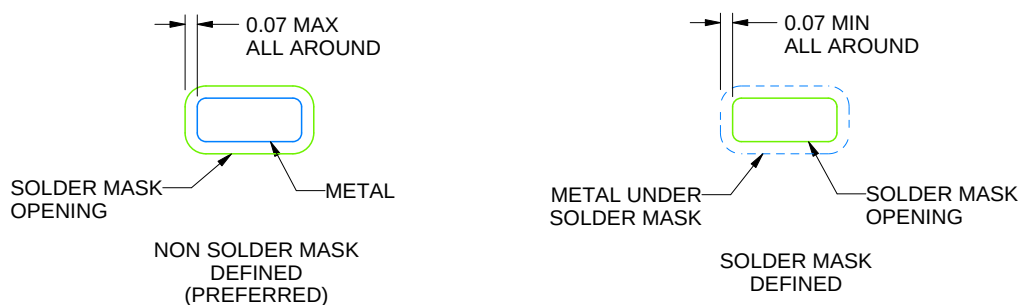
DSG0008A

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE
SCALE:20X



SOLDER MASK DETAILS

4218900/D 04/2020

NOTES: (continued)

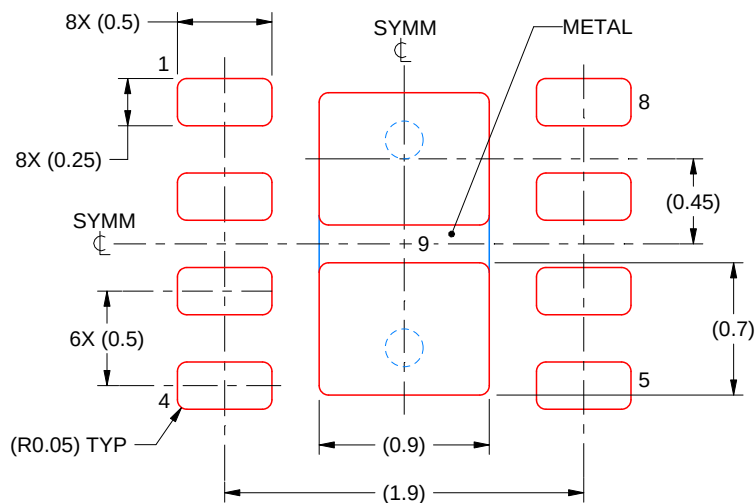
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

DSG0008A

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 9:
87% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
SCALE:25X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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